

STW11NK100Z

N-channel 1000V - 1.1Ω - 8.3A - TO-247 Zener - Protected SuperMESH™ PowerMOSFET

General features

Туре	V _{DSS} (@Tjmax)	R _{DS(on)}	I _D	Pw
STW11NK100Z	1000 V	< 1.38 Ω	8.3 A	230W

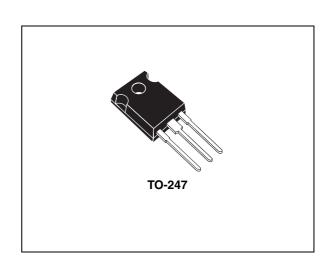
- Extremely high dv/dt capability
- 100% avalanche tested
- Gate charge minimized
- Very low intrinsic capacitances
- Very good manufacturing repeatibility

Description

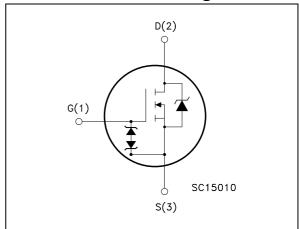
The SuperMESH™ series is obtained through an extreme optimization of ST's well established strip-based PowerMESH™ layout. In addition to pushing on-resistance significantly down, special care is taken to ensure a very good dv/dt capability for the most demanding applications. Such series complements ST full range of high voltage MOSFETs including revolutionary MDmesh™ products.

Applications

■ Switching application



Internal schematic diagram



Order codes

Part number	mber Marking Package		Packaging
STW11NK100Z	W11NK100Z	TO-247	Tube

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STW11NK100Z Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage (V _{GS} = 0)	1000	V
V _{DGR}	Drain-gate voltage ($R_{GS} = 20K\Omega$)	1000	V
V _{GS}	Gate-source voltage	± 30	V
I _D	Drain current (continuous) at T _C = 25°C	8.3	Α
I _D	Drain current (continuous) at T _C =100°C	5.2	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	33.2	Α
P _{TOT}	Total dissipation at T _C = 25°C	230	W
	Derating Factor	1.85	W/°C
V _{ESD (G-S)}	Gate source ESD(HBM-C=100pF, R=1,5KΩ)	6000	V
dv/dt ⁽²⁾	Peak diode recovery voltage slope	4.5	V/ns
T _J T _{stg}	Operating junction temperature Storage temperature	-55 to 150	°C

^{1.} Pulse width limited by safe operating area

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case Max	0.54	°C/W
R _{thj-a}	Thermal resistance junction-ambient Max	50	°C/W
T _I	Maximum lead temperature for soldering purpose	300	°C

Table 3. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not-repetitive (pulse width limited by Tj Max)	8.3	Α
E _{AS}	Single pulse avalanche energy (starting Tj=25°C, Id=lar, Vdd=50V)	550	mJ

^{2.} $I_{SD} \le 8.3 \text{ A}$, di/dt $\le 200 \text{A/}\mu\text{s}$, $V_{DD} \le V_{(BR)DSS}$, $T_j \le T_{JMAX}$

Electrical ratings STW11NK100Z

Table 4. Gate-source zener diode

Symbol	Parameter	Parameter Test conditions		Тур.	Max.	Unit
BV _{GSO}	Gate-source breakdown voltage	Igs=± 1mA (Open Drain)	30		0	V

Protection features of gate-to-source zener diodes

The built-in back-to-back Zener diodes have specifically been designed to enhance not only the device's ESD capability, but also to make them safely absorb possible voltage transients that may occasionally be applied from gate to source. In this respect the Zener voltage is appropriate to achieve an efficient and cost-effective intervention to protect the device's integrity. These integrated Zener diodes thus avoid the usage of external components.

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 5. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1mA, V _{GS} = 0	1000			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = Max rating, V_{DS} = Max rating, T_{C} = 125°C			1 50	μ Α μ Α
I _{GSS}	Gate body leakage current (V _{GS} = 0)	V _{GS} = ± 20V			±10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 100 \mu A$	3	3.75	4.5	٧
R _{DS(on)}	Static drain-source on resistance	$V_{GS} = 10V, I_D = 4.15 A$		1.1	1.38	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
g _{fs} ⁽¹⁾	Forward transconductance	V _{DS} =15V, I _D = 4.15A		9		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} =25V, f=1 MHz, V _{GS} =0		3500 270 60		pF pF pF
C _{osseq} (2)	Equivalent output capacitance	V _{GS} =0, V _{DS} =0V to 500V		170		pF
$t_{\rm d(on)} \\ t_{\rm r} \\ t_{\rm d(off)} \\ t_{\rm f}$	Turn-on delay time Rise time Off-voltage rise time Fall time	V_{DD} =800 V, I_{D} = 8A, R_{G} =4.7 Ω , V_{GS} =10V (see <i>Figure 16</i>)		27 18 98 55		ns ns ns
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 800V, I_{D} = 8A$ $V_{GS} = 10V$		113 18 60	162	nC nC nC

^{1.} Pulsed: pulse duration=300 μ s, duty cycle 1.5%

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^{2.} $C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Electrical characteristics STW11NK100Z

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current				8.3	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				33.2	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} =8.3A, V _{GS} =0			1.6	٧
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} =8.3, di/dt = 100A/ μ s, V_{DD} =80V, Tj=25°C (see <i>Figure 18</i>)		560 4.48 16		ns µC A
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} =8A, di/dt = 100A/ μ s, V_{DD} =80V, Tj=150°C (see <i>Figure 18</i>)		620 4.57 16		ns μC Α

^{1.} Pulse width limited by safe operating area

^{2.} Pulsed: pulse duration=300µs, duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

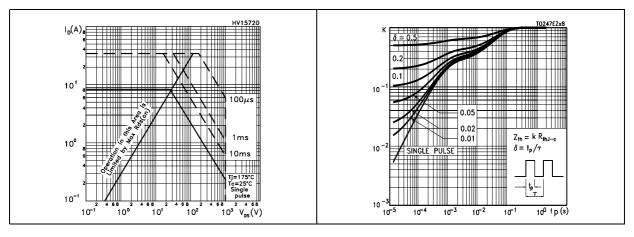


Figure 3. Output characterisics

Figure 4. Transfer characteristics

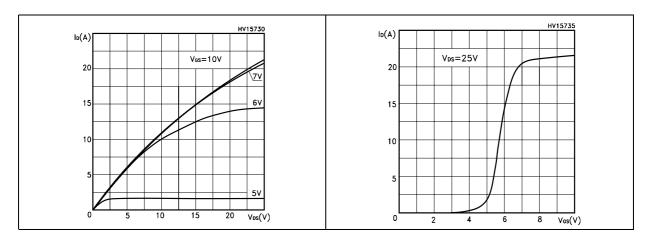
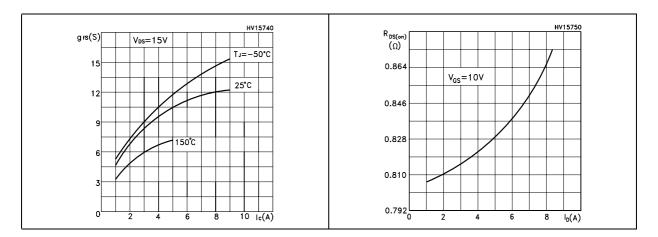


Figure 5. Transconductance

Figure 6. Static drain-source on resistance



Electrical characteristics STW11NK100Z

Figure 7. Gate charge vs gate-source voltage Figure 8. Capacitance variations

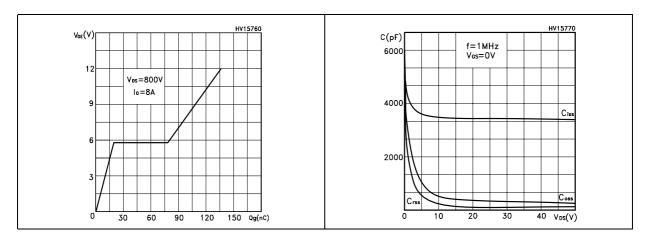


Figure 9. Normalized gate threshold voltage vs temperature

Figure 10. Normalized on resistance vs temperature

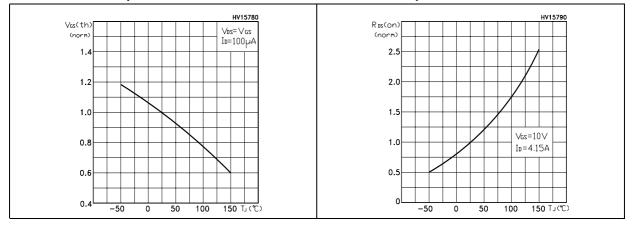
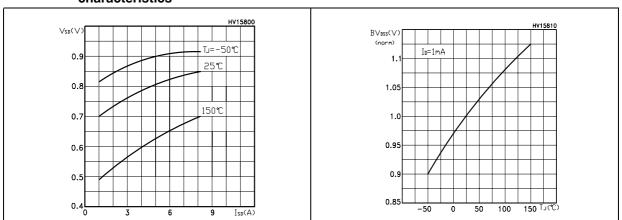


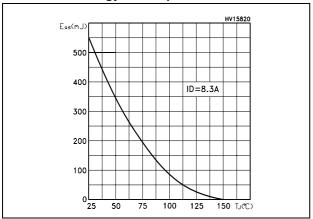
Figure 11. Source-drain diode forward characteristics

Figure 12. Normalized B_{VDSS} vs temperature



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Figure 13. Maximum avalanche energy vs temperature



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3 Test circuit Package mechanical data

Figure 14. Unclamped Inductive load test circuit

Figure 15. Unclamped Inductive waveform

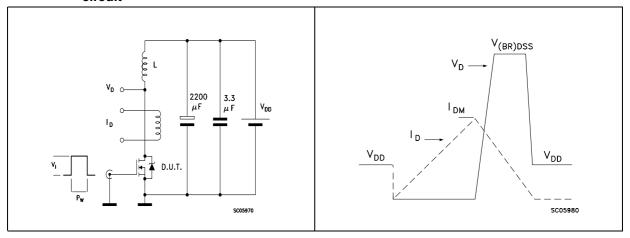


Figure 16. Switching times test circuit for resistive load

Figure 17. Gate charge test circuit

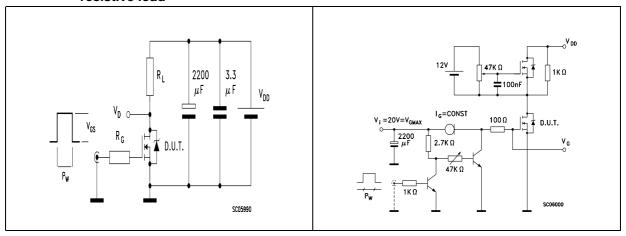
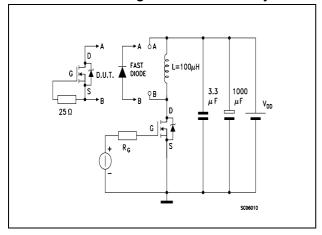


Figure 18. Test circuit for inductive load switching and diode recovery times



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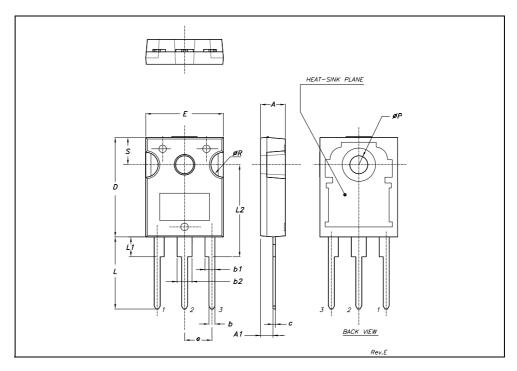
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

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TO-247 MECHANICAL DATA

DIM.		mm.			inch	
DIN.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	4.85		5.15	0.19		0.20
A1	2.20		2.60	0.086		0.102
b	1.0		1.40	0.039		0.055
b1	2.0		2.40	0.079		0.094
b2	3.0		3.40	0.118		0.134
С	0.40		0.80	0.015		0.03
D	19.85		20.15	0.781		0.793
Е	15.45		15.75	0.608		0.620
е		5.45			0.214	
L	14.20		14.80	0.560		0.582
L1	3.70		4.30	0.14		0.17
L2		18.50			0.728	
øΡ	3.55		3.65	0.140		0.143
øR	4.50		5.50	0.177		0.216
S		5.50			0.216	



STW11NK100Z Revision history

5 Revision history

Table 8. Revision history

Date	Revision	Changes	
21-Jun-2004	1	Preliminary version	
31-Jul-2006	2	New template, no content change.	

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